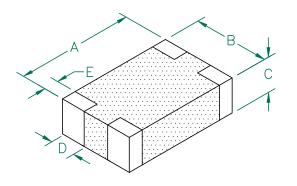
CM1812X330R-00

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

Α	4.57 [.180]	± 0.25 [.010]
В	3.05 [.120]	± 0.25 [.010]
С	1.60 [.063]	± 0.25 [.010]
D	1.14 [.045]	± 0.13 [.005]
Ε	0.58 [.023]	± 0.18 [.007]



COMMON	MMON MODE ELECTRICAL CHARACTERISTICS:						
COMMON MODE Z @ 100 MHz(Ω)		COMMON MO © 500 MHz(DE Z Ω)	DCR (Ω)	CONTINOUS Rated Current		
Nominal (Ref)	33	Nominal (Ref)	50				
Minimum	25		-				
Maximum	41		_	0.003	10,000 mA		

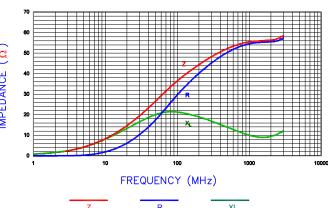
NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2500 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. U.S. PATENT 6,288,626 SHOULD APPEAR ON THE LABEL OF EACH REEL OF PACKAGED PARTS.
- 4. MINIMUM LINE TO LINE RESISTANCE $75M\Omega$.

MPEDANCE FREQUENCY (MHz)

Z vs. FREQUENCY (C,N,O)

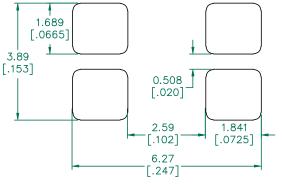




AGILENT E4991A RF Impedance/Material Analyzer

HP 16194A Test Fixture. TEST REF. 4194

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762

RECOMMENDED SOLDERING CONDITIONS REFLOW SOLDERING PRE-HEATING **SOLDERING** 230 (O.) **TEMPERATURE** [266] 60 SECONDS

.0.	30]	to this dimension.)			5 - 10	SECOND	IS 60	SECONI	05	
				THIS DOCUMENT CONTAINS INFORMATION WHICH IS PROPRIETARY AND CONFIDENTIAL TO STEWARD. NO PRODUCTION OR PUBLICATION OF						
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ł					PROJECT/PART NUMBER:	REV	PART TY	PE:	DRAWN BY:	
ł					CM1812X330R-00	Α	CO-	-FIRE	JRK	
			1 1		I ()//26/04 I	SCALE: N	TS	SHEET:	•	
ł	REV	ORIGINAL DRAFT DESCRIPTION	07/26/04 DATE	JRK	, ,	TOOL #	1812	2	of 2	